

S-82B1A Series

www.ablic.com

BATTERY PROTECTION IC WITH CHARGE-DISCHARGE CONTROL FUNCTION FOR 1-CELL PACK

© ABLIC Inc., 2016-2020 Rev.1.3_00

The S-82B1A Series is a protection IC for lithium-ion / lithium polymer rechargeable batteries and includes high-accuracy voltage detection circuits and delay circuits. It is suitable for protecting 1-cell lithium-ion / lithium polymer rechargeable battery packs from overcharge, overdischarge, and overcurrent.

The S-82B1A Series has an input pin for charge-discharge control signal, allowing for charge-discharge control with an external signal.

■ Features

• High-accuracy voltage detection circuit

Overcharge detection voltage 3.500 V to 4.600 V (5 mV step) Accuracy ±20 mV Overcharge release voltage 3.100 V to 4.600 V*1 Accuracy ±50 mV 2.000 V to 3.000 V (10 mV step) Overdischarge detection voltage Accuracy ±50 mV Overdischarge release voltage 2.000 V to 3.400 V*2 Accuracy ±100 mV 0.010 V to 0.100 V (1 mV step) Discharge overcurrent detection voltage 1 Accuracy ±3 mV Discharge overcurrent detection voltage 2 0.030 V to 0.200 V (1 mV step) Accuracy ±5 mV Load short-circuiting detection voltage 0.050 V to 0.500 V (5 mV step) Accuracy ±20 mV Charge overcurrent detection voltage -0.100 V to -0.010 V (1 mV step) Accuracy ±3 mV

• Detection delay times are generated only by an internal circuit (external capacitors are unnecessary).

· Charge-discharge control function

CTL pin control logic: Active "H", active "L" CTL pin internal resistance: Pull-up, pull-down

CTL pin internal resistance value: $1.0 \text{ M}\Omega$, $2.0 \text{ M}\Omega$, $3.0 \text{ M}\Omega$, $4.0 \text{ M}\Omega$, $5.0 \text{ M}\Omega$

0 V battery charge: Enabled, inhibited
 Power-down function: Available, unavailable

• Release condition of discharge overcurrent status: Load disconnection, charger connection

· Release voltage of discharge overcurrent status:

Discharge overcurrent detection voltage 1 (VDIOV1),

Discharge overcurrent release voltage (VRIOV) = $V_{DD} \times 0.8$ (typ.)

High-withstand voltage:
 VM pin and CO pin: Absolute maximum rating 28 V

• Wide operation temperature range: Ta = -40°C to +85°C

• Low current consumption

During operation: 2.0 μ A typ., 4.0 μ A max. (Ta = +25°C)

During power-down: 50 nA max. (Ta = +25°C) During overdischarge: 500 nA max. (Ta = +25°C)

• Lead-free (Sn 100%), halogen-free

- *1. Overcharge release voltage = Overcharge detection voltage Overcharge hysteresis voltage (Overcharge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.4 V in 50 mV step.)
- *2. Overdischarge release voltage = Overdischarge detection voltage + Overdischarge hysteresis voltage (Overdischarge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.7 V in 100 mV step.)

■ Applications

- Lithium-ion rechargeable battery pack
- Lithium polymer rechargeable battery pack

■ Package

• SNT-6A

■ Block Diagram

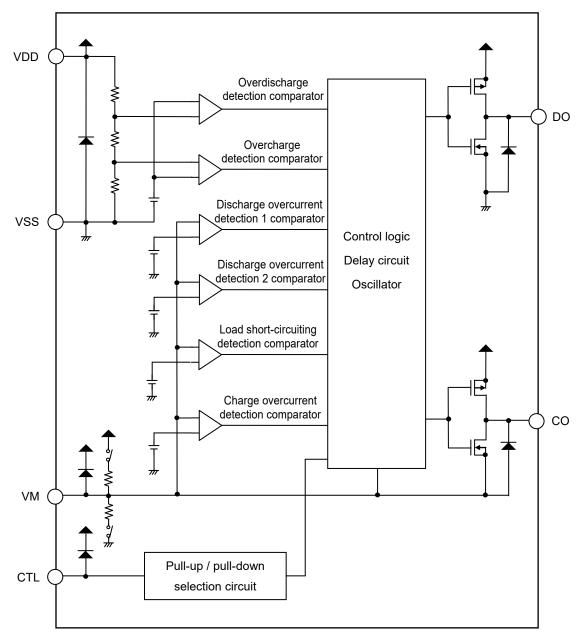
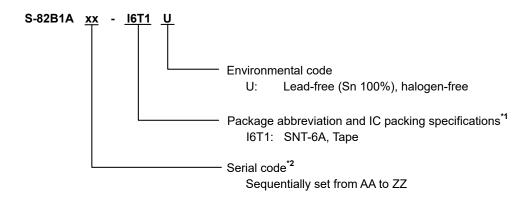


Figure 1

■ Product Name Structure

1. Product name



- *1. Refer to the tape drawing.
- *2. Refer to "3. Product name list".

2. Package

Table 1 Package Drawing Codes

Package Name	Dimension	Tape	Reel	Land
SNT-6A	PG006-A-P-SD	PG006-A-C-SD	PG006-A-R-SD	PG006-A-L-SD

3. Product name list

3.1 SNT-6A

Table 2 (1 / 2)

Product Name	Overcharge Detection Voltage [V _{CU}]	Overcharge Release Voltage [V _{CL}]	Overdischarge Detection Voltage [V _{DL}]	Overdischarge Release Voltage [V _{DU}]	Delay Time Combination*1	Function Combination*2
S-82B1AAA-I6T1U	4.475 V	4.275 V	2.500 V	2.900 V	(1)	(1)
S-82B1AAB-I6T1U	4.375 V	4.175 V	2.500 V	2.900 V	(2)	(2)
S-82B1AAF-I6T1U	4.275 V	4.075 V	2.500 V	2.900 V	(3)	(3)

Table 2 (2 / 2)

Product Name	Discharge Overcurrent Detection Voltage 1	Discharge Overcurrent Detection Voltage 2	Load Short-circuiting Detection Voltage	Charge Overcurrent Detection Voltage
	[V _{DIOV1}]	[V _{DIOV2}]	[V _{SHORT}]	[V _{CIOV}]
S-82B1AAA-I6T1U	0.060 V	0.080 V	0.200 V	-0.040 V
S-82B1AAB-I6T1U	0.050 V	1	0.100 V	-0.050 V
S-82B1AAF-I6T1U	0.070 V	0.080 V	0.200 V	-0.090 V

^{*1.} Refer to **Table 3** about the details of the delay time combinations.

Remark Please contact our sales representatives for products other than the above.

^{*2.} Refer to **Table 5** about the details of the function combinations.

BATTERY PROTECTION IC WITH CHARGE-DISCHARGE CONTROL FUNCTION FOR 1-CELL PACK S-82B1A Series Rev.1.3_00

Table 3

Delay Time Combination	Overcharge Detection Delay Time [t _{CU}]	Overdischarge Detection Delay Time [t _{DL}]	Discharge Overcurrent Detection Delay Time 1 [tDIOV1]	Discharge Overcurrent Detection Delay Time 2 [tDIOV2]	Load Short- circuiting Detection Delay Time [tshort]	Charge Overcurrent Detection Delay Time [tclov]	Charge- discharge Inhibition Delay Time [tcтL]
(1)	1.0 s	64 ms	4.0 s	32 ms	280 μs	8 ms	32 ms
(2)	1.0 s	64 ms	8 ms	_	280 μs	8 ms	32 ms
(3)	1.0 s	64 ms	256 ms	8 ms	280 μs	8 ms	32 ms

Remark The delay times can be changed within the range listed in **Table 4**. For details, please contact our sales representatives.

Table 4

Delay Time	Symbol			Selectio	n Range			Remark
Overcharge detection delay time	tcu	256 ms	512 ms	1.0 s	_	_	_	Select a value from the left.
Overdischarge detection delay time	t _{DL}	32 ms	64 ms	128 ms	256 ms	_	_	Select a value from the left.
Discharge overcurrent	4	4 ms	8 ms	16 ms	32 ms	64 ms	128 ms	Select a value from
detection delay time 1	t _{DIOV1}	256 ms	512 ms	1.0 s	2.0 s	4.0 s	_	the left.
Discharge overcurrent detection delay time 2	t _{DIOV2}	4 ms	8 ms	16 ms	32 ms	64 ms	128 ms	Select a value from the left.
Load short-circuiting detection delay time	tshort	280 μs	530 μs	-	-	_	_	Select a value from the left.
Charge overcurrent detection delay time	tciov	4 ms	8 ms	16 ms	32 ms	64 ms	128 ms	Select a value from the left.
Charge-discharge inhibition delay time	tстL	32 ms	64 ms	128 ms	256 ms	_	_	Select a value from the left.

Table 5

		CTL Pin				Release Condition	Release Voltage
Function Combination	Control Internal Logic*1 Resistance*2		Internal Resistance Value* ³ [R _{CTL}]	0 V Battery Charge* ⁴	Power-down Function*5	of Discharge Overcurrent Status*6	of Discharge Overcurrent Status*7
(1)	Active "H"	Pull-up	5.0 MΩ	Enabled	Unavailable	Load disconnection	V _{RIOV}
(2)	Active "H"	Pull-up	5.0 MΩ	Enabled	Available	Load disconnection	V _{RIOV}
(3)	Active "H"	Pull-up	5.0 MΩ	Inhibited	Available	Load disconnection	V _{RIOV}

^{*1.} CTL pin control logic: Active "H", active "L"

Remark Please contact our sales representatives for products with function combinations other than the above.

^{*2.} CTL pin internal resistance: Pull-up, pull-down

^{*3.} CTL pin internal resistance value: 1.0 M Ω , 2.0 M Ω , 3.0 M Ω , 4.0 M Ω , 5.0 M Ω

^{*4. 0} V battery charge: Enabled, inhibited

^{*5.} Power-down function: Available, unavailable

^{*6.} Release condition of discharge overcurrent status: Load disconnection, charger connection

^{*7.} Release voltage of discharge overcurrent status: V_{DIOV1} , $V_{RIOV} = V_{DD} \times 0.8$ (typ.)

■ Pin Configuration

1. SNT-6A

Top view



Figure 2

Table 6

Pin No.	Symbol	Description
1	VM	Overcurrent detection pin
2	СО	Connection pin of charge control FET gate (CMOS output)
3	DO	Connection pin of discharge control FET gate (CMOS output)
4	VSS	Input pin for negative power supply
5	VDD	Input pin for positive power supply
6	CTL	Input pin for charge-discharge control signal

■ Absolute Maximum Ratings

Table 7

(Ta = +25°C unless otherwise specified)

Item	Symbol	Applied Pin	Absolute Maximum Rating	Unit
Input voltage between VDD pin and VSS pin	V _{DS}	VDD	$V_{\text{SS}} - 0.3$ to $V_{\text{SS}} + 6$	V
CTL pin input voltage	V _{CTL}	CTL	$V_{DD}-6$ to $V_{DD}+0.3$	V
VM pin input voltage	V_{VM}	VM	$V_{DD}-28$ to $V_{DD}+0.3$	V
DO pin output voltage	V_{DO}	DO	$V_{\text{SS}} - 0.3 \text{ to } V_{\text{DD}} + 0.3$	V
CO pin output voltage	Vco	СО	$V_{VM}-0.3$ to $V_{DD}+0.3$	V
Power dissipation	P _D	_	400*1	mW
Operation ambient temperature	Topr	_	-40 to +85	°C
Storage temperature	T _{stg}	_	-55 to +125	°C

^{*1.} When mounted on board

[Mounted board]

(1) Board size: $114.3 \text{ mm} \times 76.2 \text{ mm} \times t1.6 \text{ mm}$ (2) Board name: JEDEC STANDARD51-7

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

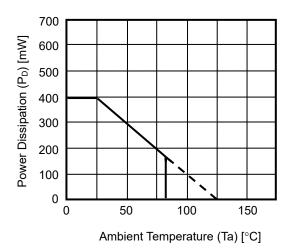


Figure 3 Power Dissipation of Package (When Mounted on Board)

■ Electrical Characteristics

1. Ta = +25°C

Table 8

(Ta = +25°C unless otherwise specified)

(Ta = +25°C unless c						spec	
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Detection Voltage							
Oversharm detection valters	V _{CU}	_	V _{CU} – 0.020	V _{CU}	$V_{CU} + 0.020$	٧	1
Overcharge detection voltage	V CU	Ta = -10° C to $+60^{\circ}$ C*1	V _{CU} – 0.025	V _{CU}	$V_{CU} + 0.025$	V	1
	V	V _{CL} ≠ V _{CU}	V _{CL} - 0.050	V _{CL}	V _{CL} + 0.050	V	1
Overcharge release voltage	V _{CL}	V _{CL} = V _{CU}	V _{CL} - 0.025	V _{CL}	V _{CL} + 0.020	V	1
Overdischarge detection voltage	V_{DL}	_	$V_{DL} - 0.050$	V_{DL}	$V_{DL} + 0.050$	V	2
Q	V	$V_{DL} \neq V_{DU}$	V _{DU} – 0.100	V_{DU}	$V_{DU} + 0.100$	V	2
Overdischarge release voltage	V_{DU}	$V_{DL} = V_{DU}$	$V_{DU} - 0.050$	V_{DU}	$V_{DU} + 0.050$	V	2
Discharge overcurrent detection voltage 1	V_{DIOV1}	-	$V_{\text{DIOV1}} - 0.003$	V_{DIOV1}	$V_{DIOV1} + 0.003$	V	2
Discharge overcurrent detection voltage 2	V_{DIOV2}	_	$V_{\text{DIOV2}}-0.005$	V_{DIOV2}	$V_{DIOV2} + 0.005$	V	2
Load short-circuiting detection voltage	V _{SHORT}	_	V _{SHORT} - 0.020	V_{SHORT}	V _{SHORT} + 0.020	٧	2
Charge overcurrent detection voltage	V _{CIOV}	-	V _{CIOV} - 0.003	V _{CIOV}	V _{CIOV} + 0.003	V	2
Discharge overcurrent release voltage	V_{RIOV}	V _{DD} = 3.4 V	$V_{DD} \times 0.77$	$V_{DD}\!\times\!0.8$	$V_{\text{DD}} \times 0.83$	V	2
0 V Battery Charge							
0 V battery charge starting charger voltage	V_{0CHA}	0 V battery charge enabled	0.0	0.7	1.0	V	2
0 V battery charge inhibition battery voltage	V_{0INH}	0 V battery charge inhibited	0.9	1.2	1.5	V	2
Internal Resistance		<u>+</u>	1		+		
Resistance between VDD pin and VM pin	R_{VMD}	$V_{DD} = 1.8 \text{ V}, V_{VM} = 0 \text{ V}$	500	1000	2000	kΩ	3
Resistance between VM pin and VSS pin	R _{VMS}	$V_{DD} = 3.4 \text{ V}, V_{VM} = 1.0 \text{ V}$	5	10	15	kΩ	3
CTL pin internal resistance	R _{CTL}	_	$R_{CTL} \times 0.5$	R _{CTL}	R _{CTL} × 2.0	$M\Omega$	3
Input Voltage	1	 	1		1	-	1
Operation voltage between VDD pin and VSS pin	V _{DSOP1}	-	1.5	_	6.0	V	-
Operation voltage between VDD pin and VM pin	V _{DSOP2}	-	1.5	-	28	٧	-
CTL pin voltage "H"	V_{CTLH}	_	_	-	$V_{DD} \times 0.9$	V	2
CTL pin voltage "L"	V _{CTLL}	-	$V_{DD} \times 0.1$	-	-	V	2
Input Current							
Current consumption during operation	I _{OPE}	$V_{DD} = 3.4 \text{ V}, V_{VM} = 0 \text{ V}$	_	2.0	4.0	μΑ	3
Current consumption during power-down	I _{PDN}	$V_{DD} = V_{VM} = 1.5 \text{ V}$	-	-	0.05	μΑ	3
Current consumption during overdischarge	I _{OPED}	$V_{DD} = V_{VM} = 1.5 \text{ V}$	_	_	0.5	μΑ	3
Output Resistance	1_	<u> </u>	 		1		1
CO pin resistance "H"	R _{COH}	_	5	10	20	kΩ	4
CO pin resistance "L"	R _{COL}	_	5	10	20	kΩ	4
DO pin resistance "H"	R _{DOH}	_	5	10	20	kΩ	4
DO pin resistance "L"	R _{DOL}	_	5	10	20	kΩ	4
Delay Time	1		4	t	440		_
Overcharge detection delay time	tou	_	$t_{CU} \times 0.7$	tou	t _{CU} × 1.3	_	5
Overdischarge detection delay time	toucya	_	$t_{DL} \times 0.7$ $t_{DIOV1} \times 0.7$	tour	$t_{DL} \times 1.3$	_	5
Discharge overcurrent detection delay time 1 Discharge overcurrent detection delay time 2	t _{DIOV}	_	$t_{DIOV1} \times 0.7$ $t_{DIOV2} \times 0.7$	t _{DIOV1}	$t_{DIOV1} \times 1.3$ $t_{DIOV1} \times 1.3$	_	5 5
Load short-circuiting detection delay time	t _{DIOV2}	_	$t_{SHORT} \times 0.7$	t _{DIOV2}	$t_{SHORT} \times 1.3$	_	5
Charge overcurrent detection delay time	t _{CIOV}		$t_{CIOV} \times 0.7$	t _{SHORT}	$t_{CIOV} \times 1.3$	_	5
Charge-discharge inhibition delay time	t _{CTL}		$t_{CTL} \times 0.7$		$t_{CTL} \times 1.3$		5
Charge-discharge inhibition delay time	*CIL	_	ICIL A U.I	t _{CTL}	ICIL A 1.3	_	J

^{*1.} Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

2. Ta = -40°C to +85°C^{*1}

Table 9

(Ta = -40°C to +85°C*1 unless otherwise specified)

	i	1	(7 100 0 0	THESS OTHERWISE		
ltem	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Detection Voltage	ı		<u>I</u>		I		
Overcharge detection voltage	V _{CU}	_	V _{CU} - 0.045	V _{CU}	V _{CU} +0.030	V	1
		V _{CL} ≠ V _{CU}	V _{CL} – 0.080	V _{CL}	V _{CL} +0.060	V	1
Overcharge release voltage	V_{CL}	$V_{CL} = V_{CU}$	V _{CL} – 0.050	V _{CL}	V _{CL} + 0.030	V	1
Overdischarge detection voltage	V_{DL}	_	V _{DL} – 0.080	V _{DL}	V _{DL} + 0.060	V	2
everalisation go detection vertage		$V_{DL} \neq V_{DU}$	V _{DU} – 0.130	V _{DU}	V _{DU} + 0.110	V	2
Overdischarge release voltage	V_{DU}	$V_{DL} = V_{DU}$	V _{DU} - 0.080	V _{DU}	V _{DU} + 0.060	V	2
Discharge overcurrent detection voltage 1	V_{DIOV1}	_	V _{DIOV1} – 0.003	V_{DIOV1}	$V_{DIOV1} + 0.003$	V	2
Discharge overcurrent detection voltage 2	V_{DIOV2}	_	$V_{\text{DIOV2}} - 0.005$	V_{DIOV2}	$V_{DIOV2} + 0.005$	V	2
Load short-circuiting detection voltage	V _{SHORT}	_	V _{SHORT} - 0.020	V _{SHORT}	V _{SHORT} + 0.020	V	2
Charge overcurrent detection voltage	V _{CIOV}	-	V _{CIOV} - 0.003	V _{CIOV}	V _{CIOV} + 0.003	V	2
Discharge overcurrent release voltage	V_{RIOV}	V _{DD} = 3.4 V	$V_{DD} \times 0.77$	$V_{DD} \times 0.8$	$V_{DD} \times 0.83$	V	2
0 V Battery Charge							
0 V battery charge starting charger voltage	V _{0CHA}	0 V battery charge enabled	0.0	0.7	1.5	V	2
0 V battery charge inhibition battery voltage	Voinh	0 V battery charge inhibited	0.7	1.2	1.7	V	2
Internal Resistance	u .			l .			ı
Resistance between VDD pin and VM pin	R _{VMD}	$V_{DD} = 1.8 \text{ V}, V_{VM} = 0 \text{ V}$	250	1000	3000	kΩ	3
Resistance between VM pin and VSS pin	R _{VMS}	$V_{DD} = 3.4 \text{ V}, V_{VM} = 1.0 \text{ V}$	3.5	10	20	kΩ	3
CTL pin internal resistance	R _{CTL}	_	R _{CTL} × 0.25	R _{CTL}	R _{CTL} × 3.0	МΩ	3
Input Voltage							l
Operation voltage between VDD pin and VSS pin	V _{DSOP1}	-	1.5	-	6.0	٧	-
Operation voltage between VDD pin and							
VM pin	V_{DSOP2}	_	1.5	_	28	V	_
CTL pin voltage "H"	V _{CTLH}	_	_	_	V _{DD} × 0.95	V	2
CTL pin voltage "L"	V _{CTLL}	_	$V_{DD} \times 0.05$	_	-	V	2
Input Current	TOTLL						_
Current consumption during operation	I _{OPE}	V _{DD} = 3.4 V, V _{VM} = 0 V	_	2.0	5.0	μΑ	3
Current consumption during power-down	I _{PDN}	$V_{DD} = V_{VM} = 1.5 \text{ V}$	_	-	0.1	μΑ	3
Current consumption during overdischarge	I _{OPED}	$V_{DD} = V_{VM} = 1.5 \text{ V}$	_	_	1.0	μΑ	3
Output Resistance	101 LD	TOD TOWN				P** 1	
CO pin resistance "H"	R _{сон}	_	2.5	10	30	kΩ	4
	R _{COL}	_	2.5	10	30	kΩ	4
DO pin resistance "H"	R _{DOH}	_	2.5	10	30	kΩ	4
DO pin resistance "L"	R _{DOL}	_	2.5	10	30	kΩ	4
Delay Time	-501	I			1	1,25	<u> </u>
Overcharge detection delay time	t _{CU}	_	$t_{\text{CU}} \times 0.4$	t _{CU}	$t_{\text{CU}}\!\times\!2.5$	_	5
Overdischarge detection delay time	t _{DL}	_	$t_{DL} \times 0.4$	t _{DL}	$t_{DL} \times 2.5$	_	5
Discharge overcurrent detection delay time 1	t _{DIOV1}	_	$t_{DIOV1} \times 0.4$	t _{DIOV1}	$t_{DIOV1} \times 2.5$	_	5
Discharge overcurrent detection delay time 2	t _{DIOV2}	_	$t_{DIOV2} \times 0.4$	t _{DIOV2}	$t_{DIOV2} \times 2.5$	_	5
Load short-circuiting detection delay time	t _{SHORT}	_	$t_{SHORT} \times 0.4$	t _{SHORT}	$t_{SHORT} \times 2.5$	_	5
Charge overcurrent detection delay time	t _{ClOV}	_	$t_{CIOV} \times 0.4$	t _{CIOV}	$t_{\text{CIOV}} \times 2.5$	_	5
Charge-discharge inhibition delay time	t _{CTL}	_	$t_{CTL} \times 0.4$	t _{CTL}	$t_{CTL} \times 2.5$	_	5
Onargo-disonargo inilibilion delay lime	-CIL	-	IUIL A U.T	UIL	ICIL ^ Z.U	_	J

^{*1.} Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

■ Test Circuits

When CTL pin control logic is active "H", SW1 and SW3 are turned off, SW2 and SW4 are turned on. When CTL pin control logic is active "L", SW1 and SW3 are turned on, SW2 and SW4 are turned off.

Caution Unless otherwise specified, the output voltage levels "H" and "L" at CO pin (V_{CO}) and DO pin (V_{DO}) are judged by the threshold voltage (1.0 V) of the N-channel FET. Judge the CO pin level with respect to V_{VM} and the DO pin level with respect to V_{SS} .

1. Overcharge detection voltage, overcharge release voltage (Test circuit 1)

Overcharge detection voltage (V_{CU}) is defined as the voltage V1 at which V_{CO} goes from "H" to "L" when the voltage V1 is gradually increased from the starting condition of V1 = 3.4 V. Overcharge release voltage (V_{CL}) is defined as the voltage V1 at which V_{CO} goes from "L" to "H" when the voltage V1 is then gradually decreased. Overcharge hysteresis voltage (V_{HC}) is defined as the difference between V_{CU} and V_{CL} .

2. Overdischarge detection voltage, overdischarge release voltage (Test circuit 2)

Overdischarge detection voltage (V_{DL}) is defined as the voltage V1 at which V_{DO} goes from "H" to "L" when the voltage V1 is gradually decreased from the starting conditions of V1 = 3.4 V, V2 = V5 = 0 V. Overdischarge release voltage (V_{DU}) is defined as the voltage V1 at which V_{DO} goes from "L" to "H" when setting V2 = 0.01 V, V5 = 0 V and when the voltage V1 is then gradually increased. Overdischarge hysteresis voltage (V_{HD}) is defined as the difference between V_{DU} and V_{DL} .

3. Discharge overcurrent detection voltage 1, discharge overcurrent release voltage (Test circuit 2)

3. 1 Release voltage of discharge overcurrent status "VDIOV1"

Discharge overcurrent detection voltage 1 (V_{DIOV1}) is defined as the voltage V2 whose delay time for changing V_{DO} from "H" to "L" is discharge overcurrent detection delay time (t_{DIOV1}) when the voltage V2 is increased from the starting conditions of V1 = 3.4 V, V2 = V5 = 0 V. V_{DO} goes from "L" to "H" when setting V2 = 3.4 V and when the voltage V2 is then gradually decreased to V_{DIOV1} typ. or lower.

3. 2 Release voltage of discharge overcurrent status "VRIOV"

 V_{DIOV1} is defined as the voltage V2 whose delay time for changing V_{DO} from "H" to "L" is t_{DIOV1} when the voltage V2 is increased from the starting conditions of V1 = 3.4 V, V2 = V5 = 0 V. Discharge overcurrent release voltage (V_{RIOV}) is defined as the voltage V2 at which V_{DO} goes from "L" to "H" when setting V2 = 3.4 V and when the voltage V2 is then gradually decreased.

4. Discharge overcurrent detection voltage 2 (Test circuit 2)

Discharge overcurrent detection voltage 2 (V_{DIOV2}) is defined as the voltage V2 whose delay time for changing V_{DO} from "H" to "L" is discharge overcurrent detection delay time 2 (t_{DIOV2}) when the voltage V2 is increased from the starting conditions of V1 = 3.4 V, V2 = V5 = 0 V.

Load short-circuiting detection voltage (Test circuit 2)

Load short-circuiting detection voltage (V_{SHORT}) is defined as the voltage V2 whose delay time for changing V_{DO} from "H" to "L" is load short-circuiting detection delay time (t_{SHORT}) when the voltage V2 is increased from the starting conditions of V1 = 3.4 V, V2 = V5 = 0 V.

6. Charge overcurrent detection voltage (Test circuit 2)

Charge overcurrent detection voltage (V_{CIOV}) is defined as the voltage V2 whose delay time for changing V_{CO} from "H" to "L" is charge overcurrent detection delay time (t_{CIOV}) when the voltage V2 is decreased from the starting conditions of V1 = 3.4 V, V2 = V5 = 0 V.

Current consumption during operation (Test circuit 3)

The current consumption during operation (I_{OPE}) is the current that flows through the VDD pin (I_{DD}) under the set conditions of V1 = 3.4 V and V2 = V5 = 0 V. However, the current flowing through the internal resistor of the CTL pin is excluded.

8. Current consumption during power-down, current consumption during overdischarge (Test circuit 3)

8. 1 With power-down function

The current consumption during power-down (I_{PDN}) is I_{DD} under the set conditions of V1 = V2 = 1.5 V, V5 = 0 V.

8. 2 Without power-down function

The current consumption during overdischarge (I_{OPED}) is I_{DD} under the set conditions of V1 = V2 = 1.5 V, V5 = 0 V.

9. Resistance between VDD pin and VM pin (Test circuit 3)

R_{VMD} is the resistance between VDD pin and VM pin under the set conditions of V1 = 1.8 V, V2 = V5 = 0 V.

10. Resistance between VM pin and VSS pin (Release condition of discharge overcurrent status "load disconnection")

(Test circuit 3)

R_{VMS} is the resistance between VM pin and VSS pin under the set conditions of V1 = 3.4 V, V2 = 1.0 V, V5 = 0 V.

11. CTL pin internal resistance

(Test circuit 3)

11. 1 CTL pin control logic active "H", CTL pin internal resistance "pull-up"

Resistance between CTL pin and VDD pin is the CTL pin internal resistance (R_{CTL}) under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

11. 2 CTL pin control logic active "H", CTL pin internal resistance "pull-down"

Resistance between CTL pin and VSS pin is RCTL under the set conditions of V1 = V5 = 3.4 V, V2 = 0 V.

11. 3 CTL pin control logic active "L", CTL pin internal resistance "pull-up"

Resistance between CTL pin and VDD pin is RCTL under the set conditions of V1 = V5 = 3.4 V, V2 = 0 V.

11. 4 CTL pin control logic active "L", CTL pin internal resistance "pull-down"

Resistance between CTL pin and VSS pin is R_{CTL} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

12. CO pin resistance "H"

(Test circuit 4)

The CO pin resistance "H" (R_{COH}) is the resistance between VDD pin and CO pin under the set conditions of V1 = 3.4 V, V2 = 0 V, V3 = 3.0 V.

13. CO pin resistance "L" (Test circuit 4)

The CO pin resistance "L" (R_{COL}) is the resistance between VM pin and CO pin under the set conditions of V1 = 4.7 V, V2 = 0 V, V3 = 0.4 V.

14. DO pin resistance "H"

(Test circuit 4)

The DO pin resistance "H" (R_{DOH}) is the resistance between VDD pin and DO pin under the set conditions of V1 = 3.4 V, V2 = 0 V, V4 = 3.0 V.

15. DO pin resistance "L" (Test circuit 4)

The DO pin resistance "L" (R_{DOL}) is the resistance between VSS pin and DO pin under the set conditions of V1 = 1.8 V, V2 = 0 V, V4 = 0.4 V.

CTL pin voltage "H", CTL pin voltage "L" (Test circuit 2)

16. 1 CTL pin control logic active "H"

The CTL pin voltage "H" (V_{CTLH}) is defined as the voltage V5 at which V_{CO} and V_{DO} go from "H" to "L" when the voltage V5 is gradually increased under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V. After that, the CTL pin voltage "L" (V_{CTLL}) is defined as the voltage V5 at which V_{CO} and V_{DO} go from "L" to "H" after V5 is gradually decreased.

16. 2 CTL pin control logic active "L"

The CTL pin voltage "L" (V_{CTLL}) is defined as the voltage difference between the voltage V5 and the voltage V1 (V1 – V5) at which V_{DO} goes from "H" to "L" when the voltage V5 is gradually increased under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V. After that, the CTL pin voltage "H" (V_{CTLH}) is defined as the voltage difference between V1 – V5 at which V_{CO} and V_{DO} go from "L" to "H" after V5 is gradually decreased.

17. Overcharge detection delay time (Test circuit 5)

The overcharge detection delay time (t_{CU}) is the time needed for V_{CO} to go to "L" just after the voltage V1 increases and exceeds V_{CU} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

18. Overdischarge detection delay time (Test circuit 5)

The overdischarge detection delay time (t_{DL}) is the time needed for V_{DO} to go to "L" after the voltage V1 decreases and falls below V_{DL} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

Discharge overcurrent detection delay time 1 (Test circuit 5)

The discharge overcurrent detection delay time 1 (t_{DIOV1}) is the time needed for V_{DO} to go to "L" after the voltage V2 increases and exceeds V_{DIOV1} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

20. Discharge overcurrent detection delay time 2 (Test circuit 5)

The discharge overcurrent detection delay time 2 (t_{DIOV2}) is the time needed for V_{DO} to go to "L" after the voltage V2 increases and exceeds V_{DIOV2} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

21. Load short-circuiting detection delay time (Test circuit 5)

The load short-circuiting detection delay time (t_{SHORT}) is the time needed for V_{DO} to go to "L" after the voltage V2 increases and exceeds V_{SHORT} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

22. Charge overcurrent detection delay time (Test circuit 5)

The charge overcurrent detection delay time (t_{CIOV}) is the time needed for V_{CO} to go to "L" after the voltage V2 decreases and falls below V_{CIOV} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

23. Charge-discharge inhibition delay time (Test circuit 5)

23. 1 CTL pin control logic active "H"

Charge-discharge inhibition delay time (t_{CTL}) is the time needed for V_{CO} and V_{DO} to go to "L" after the voltage V5 increases and exceeds V_{CTLH} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

23. 2 CTL pin control logic active "L"

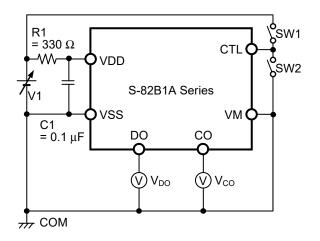
Charge-discharge inhibition delay time (t_{CTL}) is the time needed for V_{CO} and V_{DO} to go to "L" after the voltage V5 increases and V1 – V5 falls below V_{CTLL} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

24. 0 V battery charge starting charger voltage (0 V battery charge enabled) (Test circuit 2)

The 0 V battery charge starting charger voltage (V_{OCHA}) is defined as the absolute value of voltage V2 at which V_{CO} goes to "H" ($V_{\text{CO}} = V_{\text{DD}}$) when the voltage V2 is gradually decreased from the starting condition of V1 = V2 = V5 = 0 V.

0 V battery charge inhibition battery voltage (0 V battery charge inhibited) (Test circuit 2)

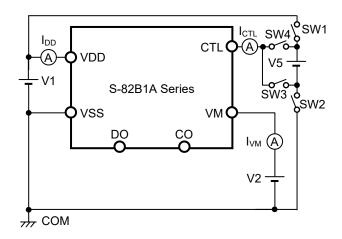
The 0 V battery charge inhibition battery voltage (V_{OINH}) is defined as the voltage V1 at which V_{CO} goes to "L" ($V_{CO} = V_{VM}$) when the voltage V1 is gradually decreased, after setting V1 = 1.9 V, V2 = -2.0 V, V5 = 0 V.



SW1 SW4 CTL C VDD **-** ∨1 S-82B1A Series SW3 /c SW2 VSS VM Ç DO CO $(V) V_{DO}$ $(V) V_{CO}$ V2 · ₩ сом

Figure 4 Test Circuit 1

Figure 5 Test Circuit 2



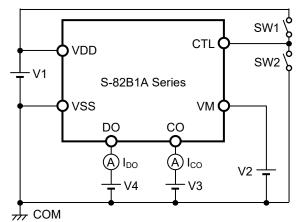


Figure 6 Test Circuit 3

Figure 7 Test Circuit 4

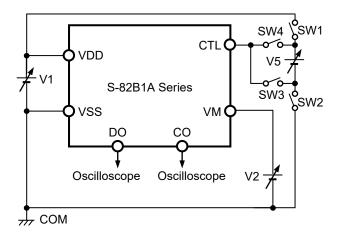


Figure 8 Test Circuit 5

Operation

Remark Refer to "■ Battery Protection IC Connection Example".

1. Normal status

The S-82B1A Series monitors the voltage of the battery connected between VDD pin and VSS pin, the voltage between VM pin and VSS pin and the voltage between CTL pin and VSS pin to control charging and discharging.

1. 1 CTL pin control logic active "H"

When the battery voltage is in the range from overdischarge detection voltage (V_{DL}) to overcharge detection voltage (V_{CU}), the VM pin voltage is in the range from charge overcurrent detection voltage (V_{CIOV}) to discharge overcurrent detection voltage 1 (V_{DIOV1}), and the CTL pin voltage is equal to or lower than the CTL pin voltage "L" (V_{CTLL}), the S-82B1A Series turns both the charge-discharge control FETs on. This condition is called the normal status, and in this condition charging and discharging can be carried out freely.

The resistance between VDD pin and VM pin (R_{VMD}), and the resistance between VM pin and VSS pin (R_{VMS}) are not connected in the normal status.

1. 2 CTL pin control logic active "L"

When the battery voltage is in the range from overdischarge detection voltage (V_{CU}), to overcharge detection voltage (V_{CU}), the VM pin voltage is in the range from charge overcurrent detection voltage (V_{CIOV}) to discharge overcurrent detection voltage 1 (V_{DIOV1}), and the CTL pin voltage is equal to or higher than the CTL pin voltage "H" (V_{CTLH}), the S-82B1A Series turns both the charge-discharge control FETs on. This condition is called the normal status, and in this condition charging and discharging can be carried out freely.

The resistance between VDD pin and VM pin (R_{VMD}), and the resistance between VM pin and VSS pin (R_{VMS}) are not connected in the normal status.

Caution When the battery is connected for the first time, discharge may not be carried. In this case, short the VM pin and VSS pin, or set the VM pin voltage at the level of V_{ClOV} or higher and at the level of V_{DlOV1} or lower by connecting the charger. The S-82B1A Series then becomes the normal status.

2. Overcharge status

2. 1 $V_{CL} \neq V_{CU}$ (Product in which overcharge release voltage differs from overcharge detection voltage)

When the battery voltage becomes higher than V_{CU} during charging in the normal status and the condition continues for the overcharge detection delay time (t_{CU}) or longer, the S-82B1A Series turns the charge control FET off to stop charging. This condition is called the overcharge status.

The overcharge status is released in the following two cases.

- (1) In the case that the VM pin voltage is lower than 0.35 V typ., the S-82B1A Series releases the overcharge status when the battery voltage falls below overcharge release voltage (V_{CL}).
- (2) In the case that the VM pin voltage is equal to or higher than 0.35 V typ., the S-82B1A Series releases the overcharge status when the battery voltage falls below V_{CU} .

When the discharge is started by connecting a load after the overcharge detection, the VM pin voltage rises by the V_f voltage of the parasitic diode than the VSS pin voltage, because the discharge current flows through the parasitic diode in the charge control FET. If this VM pin voltage is equal to or higher than 0.35 V typ., the S-82B1A Series releases the overcharge status when the battery voltage is equal to or lower than V_{CU} .

Caution If the battery is charged to a voltage higher than V_{CU} and the battery voltage does not fall below V_{CU} even when a heavy load is connected, discharge overcurrent detection and load short-circuiting detection do not function until the battery voltage falls below V_{CU} . Since an actual battery has an internal impedance of tens of $m\Omega$, the battery voltage drops immediately after a heavy load that causes overcurrent is connected, and discharge overcurrent detection and load short-circuiting detection function.

BATTERY PROTECTION IC WITH CHARGE-DISCHARGE CONTROL FUNCTION FOR 1-CELL PACK Rev.1.3 00 S-82B1A Series

2. 2 VcL = VcU (Product in which overcharge release voltage is the same as overcharge detection voltage)

When the battery voltage becomes higher than V_{CU} during charging in the normal status and the condition continues for the overcharge detection delay time (t_{CU}) or longer, the S-82B1A Series turns the charge control FET off to stop charging. This condition is called the overcharge status.

In the case that the VM pin voltage is equal to or higher than 0.35 V typ. and the battery voltage falls below V_{CU} , the S-82B1A Series releases the overcharge status.

When the discharge is started by connecting a load after the overcharge detection, the VM pin voltage rises by the V_f voltage of the parasitic diode than the VSS pin voltage, because the discharge current flows through the parasitic diode in the charge control FET. If this VM pin voltage is equal to or higher than 0.35 V typ., the S-82B1A Series releases the overcharge status when the battery voltage is equal to or lower than V_{CU} .

Caution 1. If the battery is charged to a voltage higher than V_{CU} and the battery voltage does not fall below V_{CU} even when a heavy load is connected, discharge overcurrent detection and load short-circuiting detection do not function until the battery voltage falls below V_{CU}. Since an actual battery has an internal impedance of tens of mΩ, the battery voltage drops immediately after a heavy load that causes overcurrent is connected, and discharge overcurrent detection and load short-circuiting detection function.

2. When a charger is connected after overcharge detection, the overcharge status is not released even if the battery voltage is below V_{CL}. The overcharge status is released when the discharge current flows and the VM pin voltage goes over 0.35 V typ. by removing the charger.

3. Overdischarge status

When the battery voltage falls below V_{DL} during discharging in the normal status and the condition continues for the overdischarge detection delay time (t_{DL}) or longer, the S-82B1A Series turns the discharge control FET off to stop discharging. This condition is called the overdischarge status.

Under the overdischarge status, VDD pin and VM pin are shorted by R_{VMD} in the S-82B1A Series. The VM pin voltage is pulled up by R_{VMD}.

When connecting a charger in the overdischarge status, the battery voltage reaches V_{DL} or higher and the S-82B1A Series releases the overdischarge status if the VM pin voltage falls below 0 V typ.

The battery voltage reaches the overdischarge release voltage (V_{DU}) or higher and the S-82B1A Series releases the overdischarge status if the VM pin voltage does not fall below 0 V typ.

R_{VMS} is not connected in the overdischarge status.

3. 1 With power-down function

Under the overdischarge status, when voltage difference between VDD pin and VM pin is 0.8 V typ. or lower, the power-down function works and the current consumption is reduced to the current consumption during power-down (I_{PDN}). By connecting a battery charger, the power-down function is released when the VM pin voltage is 0.7 V typ. or lower.

- When a battery is not connected to a charger and the VM pin voltage ≥ 0.7 V typ., the S-82B1A Series
 maintains the overdischarge status even when the battery voltage reaches V_{DU} or higher.
- When a battery is connected to a charger and 0.7 V typ. > the VM pin voltage > 0 V typ., the battery voltage reaches V_{DU} or higher and the S-82B1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VM pin voltage, the battery voltage reaches V_{DL} or higher and the S-82B1A Series releases the overdischarge status.

3. 2 Without power-down function

Under the overdischarge status, the power-down function does not work even when voltage difference between VDD pin and VM pin is 0.8 V typ. or lower.

- When a battery is not connected to a charger and the VM pin voltage ≥ 0.7 V typ., the battery voltage reaches V_{DU} or higher and the S-82B1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0.7 V typ. > the VM pin voltage > 0 V typ., the battery voltage reaches V_{DU} or higher and the S-82B1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VM pin voltage, the battery voltage reaches V_{DL} or higher and the S-82B1A Series releases the overdischarge status.

4. Discharge overcurrent status (discharge overcurrent 1, discharge overcurrent 2, load short circuiting)

When a battery in the normal status is in the status where the VM pin voltage is equal to or higher than V_{DIOV1} because the discharge current is equal to or higher than the specified value and the status lasts for the discharge overcurrent detection delay time (t_{DIOV1}) or longer, the discharge control FET is turned off and discharging is stopped. This status is called the discharge overcurrent status.

4. 1 Release condition of discharge overcurrent status "load disconnection" and release voltage of discharge overcurrent status "V_{DIOV1}"

Under the discharge overcurrent status, VM pin and VSS pin are shorted by R_{VMS} in the S-82B1A Series. However, the VM pin voltage is the VDD pin voltage due to the load as long as the load is connected. When the load is disconnected, VM pin returns to the VSS pin voltage.

When the VM pin voltage returns to V_{DIOV1} or lower, the S-82B1A Series releases the discharge overcurrent status

R_{VMD} is not connected in the discharge overcurrent status.

4. 2 Release condition of discharge overcurrent status "load disconnection" and release voltage of discharge overcurrent status "V_{RIOV}"

Under the discharge overcurrent status, VM pin and VSS pin are shorted by R_{VMS} in the S-82B1A Series. However, the VM pin voltage is the VDD pin voltage due to the load as long as the load is connected. When the load is disconnected, VM pin returns to the VSS pin voltage.

When the VM pin voltage returns to V_{RIOV} or lower, the S-82B1A Series releases the discharge overcurrent status

R_{VMD} is not connected in the discharge overcurrent status.

4. 3 Release condition of discharge overcurrent status "charger connection"

Under the discharge overcurrent status, VDD pin and VM pin are shorted by R_{VMD} in the S-82B1A Series. When a battery is connected to a charger and the VM pin voltage returns to V_{DIOV1} or lower, the S-82B1A Series releases the discharge overcurrent status.

R_{VMS} is not connected in the discharge overcurrent status.

5. Charge overcurrent status

When a battery in the normal status is in the status where the VM pin voltage is equal to or lower than V_{CIOV} because the charge current is equal to or higher than the specified value and the status lasts for the charge overcurrent detection delay time (t_{CIOV}) or longer, the charge control FET is turned off and charging is stopped. This status is called the charge overcurrent status.

The S-82B1A Series releases the charge overcurrent status when the discharge current flows and the VM pin voltage is 0.35 V typ. or higher by removing the charger.

The charge overcurrent detection does not function in the overdischarge status.

6. Charge-discharge inhibition status

6. 1 CTL pin control logic active "H"

When the CTL pin voltage is equal to or higher than CTL pin voltage "H" (V_{CTLH}) and the status lasts for the charge-discharge inhibition delay time (t_{CTL}) or longer, the charge control FET and the discharge control FET are turned off, and charging and discharging are stopped. This status is called the charge-discharge inhibition status.

The S-82B1A Series releases charge-discharge inhibition status when the CTL pin voltage is equal to or lower than CTL pin voltage "L" (V_{CTLL}).

6. 2 CTL pin control logic active "L"

When the CTL pin voltage is equal to or lower than CTL pin voltage "L" (V_{CTLL}) and the status lasts for the charge-discharge inhibition delay time (t_{CTL}) or longer, the charge control FET and the discharge control FET are turned off, and charging and discharging are stopped. This status is called the charge-discharge inhibition status

The S-82B1A Series releases charge-discharge inhibition status when the CTL pin voltage is equal to or higher than CTL pin voltage "H" (V_{CTLH}).

When the status changes from discharge overcurrent to charge-discharge inhibition, it returns to normal status if the S-82B1A Series releases charge-discharge inhibition status. The CTL pin is shorted to the VDD pin or VSS pin by the CTL pin internal resistance (R_{CTL}) in the S-82B1A Series. When R_{CTL} becomes overdischarge status, it is disconnected and the input and output current to the CTL pin is cut off.

The charge-discharge control by the CTL pin does not function in the overdischarge status.

7. 0 V battery charge enabled

This function is used to recharge a connected battery whose voltage is 0 V due to self-discharge. When the 0 V battery charge starting charger voltage (V_{0CHA}) or a higher voltage is applied between the EB+ and EB- pins by connecting a charger, the charge control FET gate is fixed to the VDD pin voltage.

When the voltage between the gate and source of the charge control FET becomes equal to or higher than the threshold voltage due to the charger voltage, the charge control FET is turned on to start charging. At this time, the discharge control FET is off and the charging current flows through the internal parasitic diode in the discharging control FET. When the battery voltage becomes equal to or higher than V_{DL}, the S-82B1A Series enters the normal status.

- Caution 1. Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. Please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge.
 - 2. The 0 V battery charge has higher priority than the charge overcurrent detection function. Consequently, a product in which use of the 0 V battery charge is enabled charges a battery forcibly and the charge overcurrent cannot be detected when the battery voltage is lower than V_{DL}.

8. 0 V battery charge inhibited

This function inhibits charging when a battery that is internally short-circuited (0 V battery) is connected. When the battery voltage is the 0 V battery charge inhibition battery voltage (V_{0INH}) or lower, the charge control FET gate is fixed to the EB- pin voltage to inhibit charging. When the battery voltage is Voinh or higher, charging can be performed.

Caution Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. Please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge.

9. Delay circuit

The detection delay times are determined by dividing a clock of approximately 4 kHz by the counter.

tbiov1, tbiov2 and tshort start when Vbiov1 is detected. When Vbiov2 or Vshort is detected over tbiov2 or tshort after the detection of VDIOV1, the S-82B1A Series turns the discharge control FET off within tDIOV2 or tSHORT of each detection.

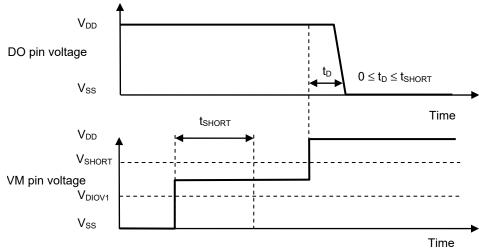
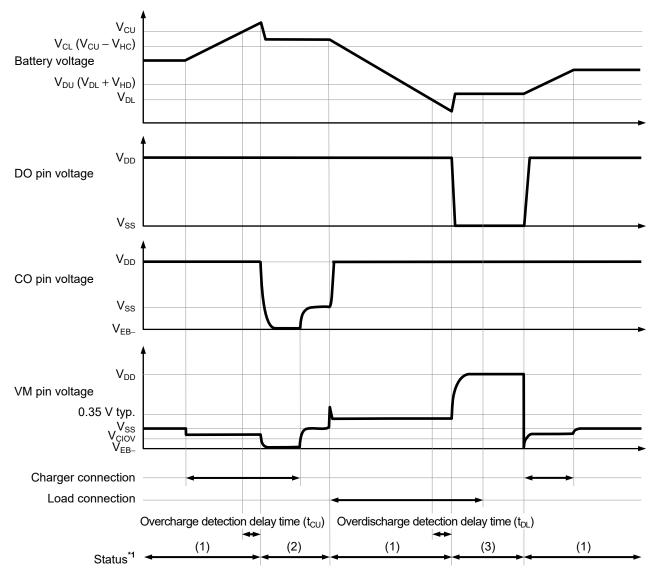


Figure 9

■ Timing Charts

1. Overcharge detection, overdischarge detection

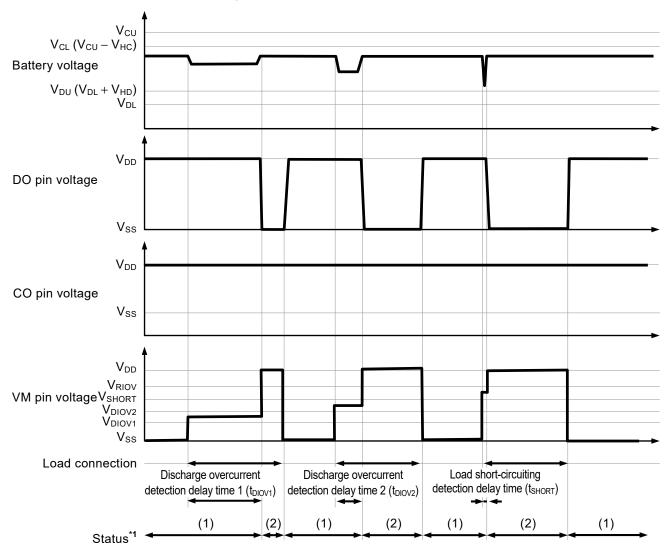


- *1. (1): Normal status
 - (2): Overcharge status
 - (3): Overdischarge status

Figure 10

2. Discharge overcurrent detection

2. 1 Release condition of discharge overcurrent status "load disconnection"

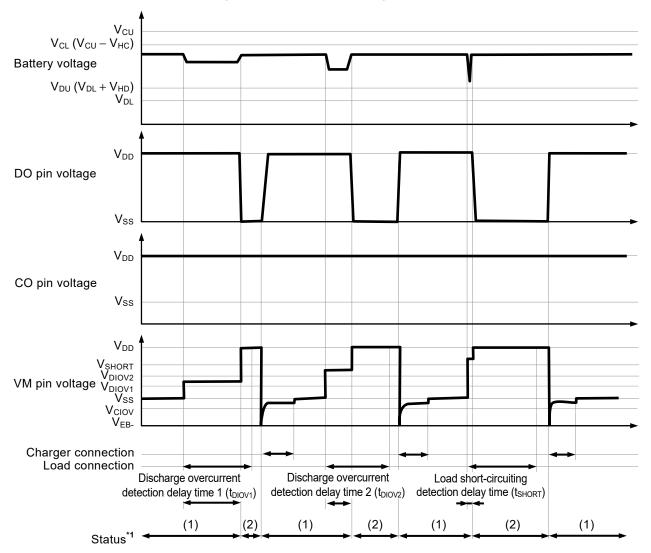


^{*1. (1):} Normal status

Figure 11

^{(2):} Discharge overcurrent status

2. 2 Release condition of discharge overcurrent status "charger connection"

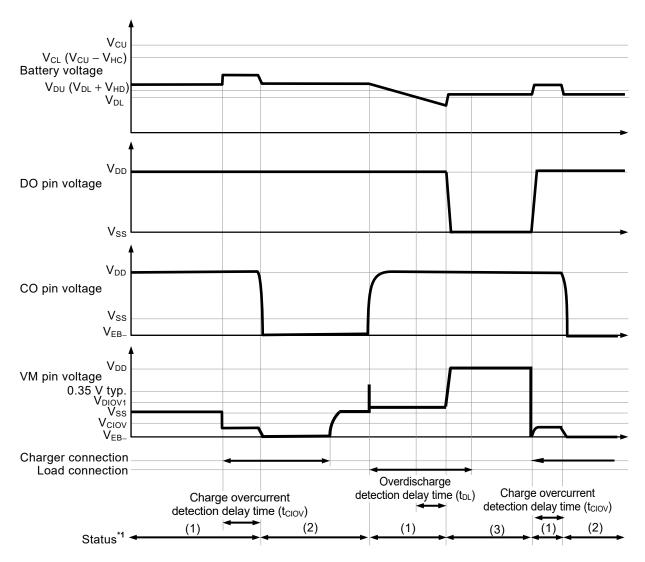


^{*1. (1):} Normal status

Figure 12

^{(2):} Discharge overcurrent status

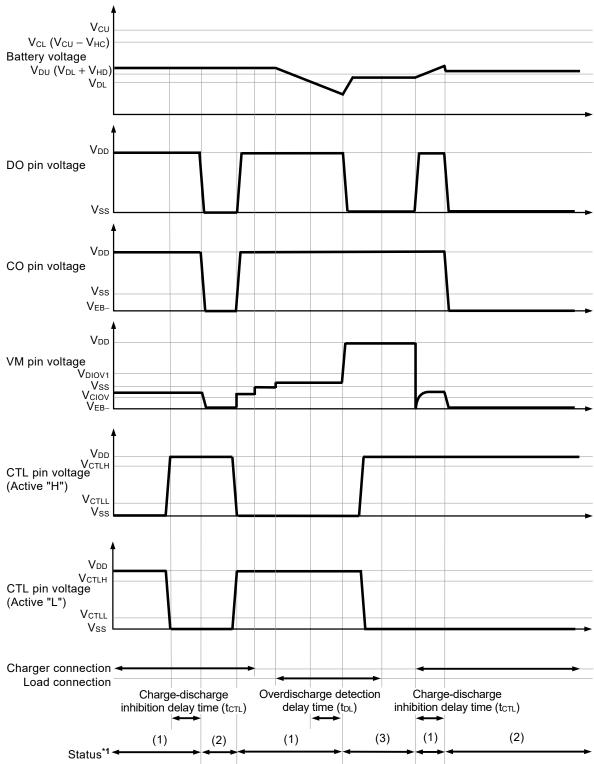
3. Charge overcurrent detection



- *1. (1): Normal status
 - (2): Charge overcurrent status
 - (3): Overdischarge status

Figure 13

4. Charge-discharge inhibition operation



- *1. (1): Normal status
 - (2): Charge-discharge inhibition status
 - (3): Overdischarge status

Remark The charger is assumed to charge with a constant current.

Figure 14

■ Battery Protection IC Connection Example

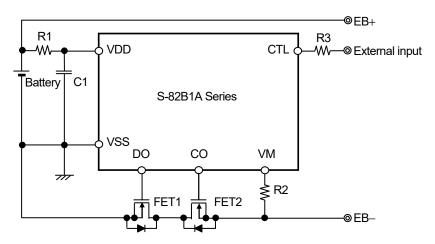


Figure 15

Table 10 Constants for External Components

Table 10 Constants for External Components						
Symbol	Part	Purpose	Min.	Тур.	Max.	Remark
FET1	N-channel MOS FET	Discharge control	_	-	-	Threshold voltage ≤ Overdischarge detection voltage*1
FET2	N-channel MOS FET	Charge control	_	-	-	Threshold voltage ≤ Overdischarge detection voltage*1
R1	Resistor	ESD protection, For power fluctuation	270 Ω	330 Ω	1 kΩ	Caution should be exercised when setting $V_{DIOV1} \le 30$ mV, $V_{CIOV} \ge -30$ mV.*2
C1	Capacitor	For power fluctuation	0.068 μF	0.1 μF	1.0 μF	Caution should be exercised when setting $V_{DIOV1} \le 30$ mV, $V_{CIOV} \ge -30$ mV.*2
R2	Resistor	ESD protection, Protection for reverse connection of a charger	300 Ω	1 kΩ	1.5 kΩ	_
R3	Resistor	CTL pin input protection	_	1 kΩ	_	_

^{*1.} If a FET with a threshold voltage equal to or higher than the overdischarge detection voltage is used, discharging may be stopped before overdischarge is detected.

Caution 1. The constants may be changed without notice.

2. It has not been confirmed whether the operation is normal or not in circuits other than the connection example. In addition, the connection example and the constants do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constants.

^{*2.} When setting $V_{DIOV1} \le 30$ mV, $V_{CIOV} \ge -30$ mV for power fluctuation protection, the condition of R1 \times C1 \ge 100 μ F • Ω should be met.

BATTERY PROTECTION IC WITH CHARGE-DISCHARGE CONTROL FUNCTION FOR 1-CELL PACK S-82B1A Series Rev.1.3_00

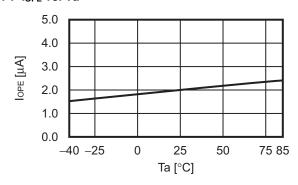
■ Precautions

- The application conditions for the input voltage, output voltage, and load current should not exceed the package power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- ABLIC Inc. claims no responsibility for any and all disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

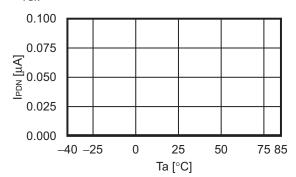
■ Characteristics (Typical Data)

1. Current consumption

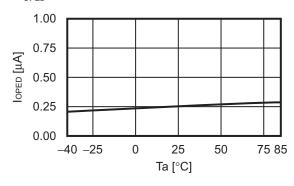
1. 1 I_{OPE} vs. Ta



1. 2 I_{PDN} vs. Ta

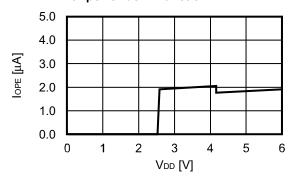


1. 3 I_{OPED} vs. Ta

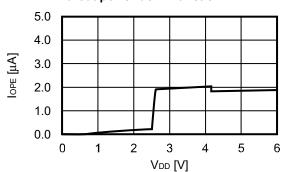


1. 4 IOPE VS. VDD

1. 4. 1 With power-down function

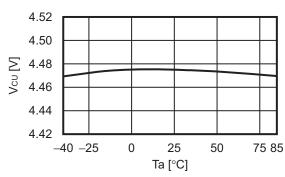


1. 4. 2 Without power-down function

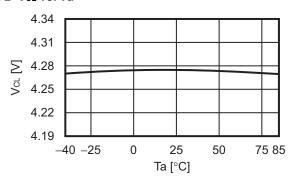


2. Detection voltage

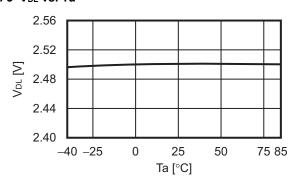
2. 1 V_{CU} vs. Ta



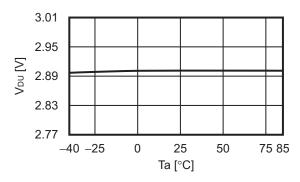
2. 2 V_{CL} vs. Ta



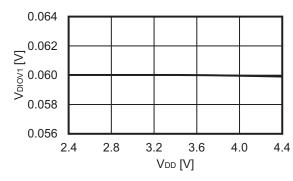
2. 3 V_{DL} vs. Ta



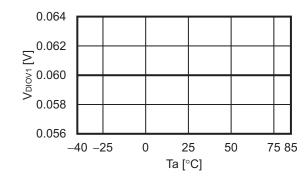
2. 4 V_{DU} vs. Ta



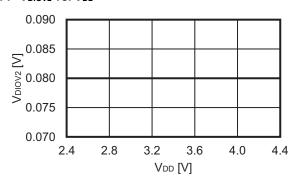
2. 5 VDIOV1 VS. VDD



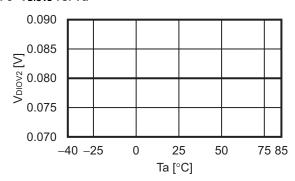
2. 6 V_{DIOV1} vs. Ta



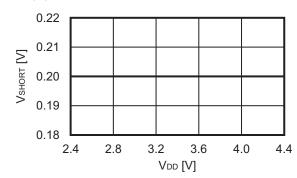
2. 7 VDIOV2 VS. VDD



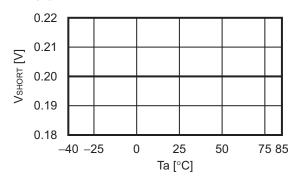
2. 8 V_{DIOV2} vs. Ta



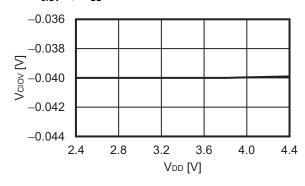
2. 9 V_{SHORT} vs. V_{DD}



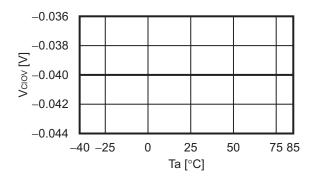
2. 10 V_{SHORT} vs. Ta



2. 11 V_{CIOV} vs. V_{DD}

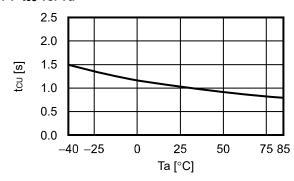


2. 12 V_{CIOV} vs. Ta

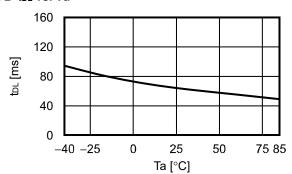


3. Delay time

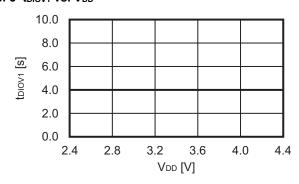
3. 1 tcu vs. Ta



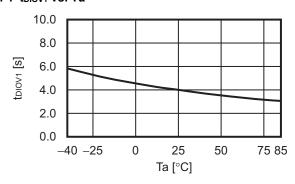
3. 2 t_{DL} vs. Ta



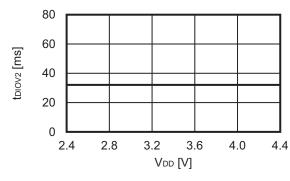
3. 3 tDIOV1 VS. VDD



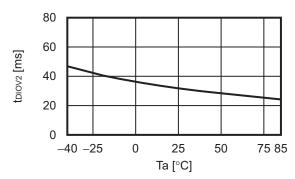
3. 4 t_{DIOV1} vs. Ta



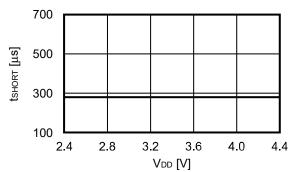
3. 5 t_{DIOV2} vs. V_{DD}



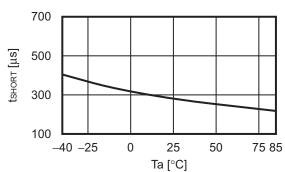
3. 6 t_{DIOV2} vs. Ta



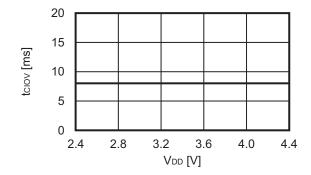
3. 7 t_{SHORT} vs. V_{DD}



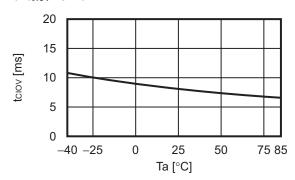
3.8 t_{SHORT} vs. Ta



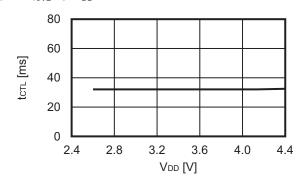
3. 9 tciov vs. VDD



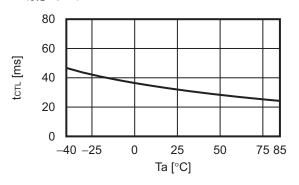
3. 10 tciov vs. Ta



3. 11 tcTL vs. VDD

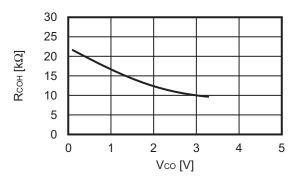


3. 12 tcтL vs. Та

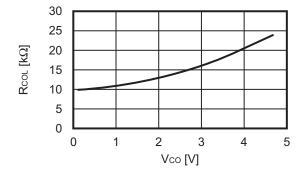


4. Output resistance

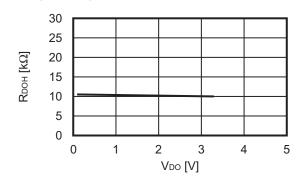
4. 1 R_{COH} vs. V_{CO}



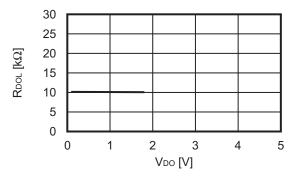
4. 2 R_{COL} vs. V_{CO}



4. 3 RDOH VS. VDO



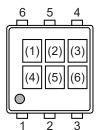
4. 4 RDOL VS. VDO



■ Marking Specifications

1. SNT-6A

Top view



(1) to (3): Product code (refer to **Product name vs. Product code**)

(4) to (6): Lot number

Product name vs. Product code

Product Name	Product Code					
Product Name	(1)	(2)	(3)			
S-82B1AAA-I6T1U	6	D	Α			
S-82B1AAB-I6T1U	6	D	В			
S-82B1AAF-I6T1U	6	D	F			

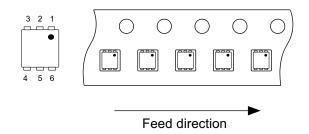




No. PG006-A-P-SD-2.1

TITLE	SNT-6A-A-PKG Dimensions	
No.	PG006-A-P-SD-2.1	
ANGLE	\$ E3	
UNIT	mm	
ABLIC Inc		
ABLIC Inc.		





No. PG006-A-C-SD-2.0

TITLE	SNT-6A-A-Carrier Tape	
No.	PG006-A-C-SD-2.0	
ANGLE		
UNIT	mm	
ABLIC Inc.		



TITLE	SNT-6A-A-Reel			
No.	PG006-A-R-SD-1.0			
ANGLE		QTY.	5,000	
UNIT	mm			
ABLIC Inc.				



※1. ランドパターンの幅に注意してください (0.25 mm min. / 0.30 mm typ.)。 ※2. パッケージ中央にランドパターンを広げないでください (1.30 mm ~ 1.40 mm)。

- 注意 1. パッケージのモールド樹脂下にシルク印刷やハンダ印刷などしないでください。
 - 2. パッケージ下の配線上のソルダーレジストなどの厚みをランドパターン表面から0.03 mm 以下にしてください。
 - 3. マスク開口サイズと開口位置はランドパターンと合わせてください。
 - 4. 詳細は "SNTパッケージ活用の手引き"を参照してください。
- ※1. Pay attention to the land pattern width (0.25 mm min. / 0.30 mm typ.).
- ※2. Do not widen the land pattern to the center of the package (1.30 mm ~ 1.40 mm).
- Caution 1. Do not do silkscreen printing and solder printing under the mold resin of the package.
 - 2. The thickness of the solder resist on the wire pattern under the package should be 0.03 mm or less from the land pattern surface.
 - 3. Match the mask aperture size and aperture position with the land pattern.
 - 4. Refer to "SNT Package User's Guide" for details.
- ※1. 请注意焊盘模式的宽度 (0.25 mm min. / 0.30 mm typ.)。
- ※2. 请勿向封装中间扩展焊盘模式 (1.30 mm~1.40 mm)。
- 注意 1. 请勿在树脂型封装的下面印刷丝网、焊锡。
 - 2. 在封装下、布线上的阻焊膜厚度 (从焊盘模式表面起) 请控制在 0.03 mm 以下。
 - 3. 钢网的开口尺寸和开口位置请与焊盘模式对齐。
 - 4. 详细内容请参阅 "SNT 封装的应用指南"。

No. PG006-A-L-SD-4.1

TITLE	SNT-6A-A -Land Recommendation		
No.	PG006-A-L-SD-4.1		
ANGLE			
UNIT	mm		
ABLIC Inc.			

Disclaimers (Handling Precautions)

- 1. All the information described herein (product data, specifications, figures, tables, programs, algorithms and application circuit examples, etc.) is current as of publishing date of this document and is subject to change without notice.
- 2. The circuit examples and the usages described herein are for reference only, and do not guarantee the success of any specific mass-production design.
 - ABLIC Inc. is not liable for any losses, damages, claims or demands caused by the reasons other than the products described herein (hereinafter "the products") or infringement of third-party intellectual property right and any other right due to the use of the information described herein.
- 3. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by the incorrect information described herein.
- 4. Be careful to use the products within their ranges described herein. Pay special attention for use to the absolute maximum ratings, operation voltage range and electrical characteristics, etc.
 - ABLIC Inc. is not liable for any losses, damages, claims or demands caused by failures and / or accidents, etc. due to the use of the products outside their specified ranges.
- 5. Before using the products, confirm their applications, and the laws and regulations of the region or country where they are used and verify suitability, safety and other factors for the intended use.
- 6. When exporting the products, comply with the Foreign Exchange and Foreign Trade Act and all other export-related laws, and follow the required procedures.
- 7. The products are strictly prohibited from using, providing or exporting for the purposes of the development of weapons of mass destruction or military use. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by any provision or export to the person or entity who intends to develop, manufacture, use or store nuclear, biological or chemical weapons or missiles, or use any other military purposes.
- 8. The products are not designed to be used as part of any device or equipment that may affect the human body, human life, or assets (such as medical equipment, disaster prevention systems, security systems, combustion control systems, infrastructure control systems, vehicle equipment, traffic systems, in-vehicle equipment, aviation equipment, aerospace equipment, and nuclear-related equipment), excluding when specified for in-vehicle use or other uses by ABLIC, Inc. Do not apply the products to the above listed devices and equipments.
 - ABLIC Inc. is not liable for any losses, damages, claims or demands caused by unauthorized or unspecified use of the products.
- 9. In general, semiconductor products may fail or malfunction with some probability. The user of the products should therefore take responsibility to give thorough consideration to safety design including redundancy, fire spread prevention measures, and malfunction prevention to prevent accidents causing injury or death, fires and social damage, etc. that may ensue from the products' failure or malfunction.
 - The entire system in which the products are used must be sufficiently evaluated and judged whether the products are allowed to apply for the system on customer's own responsibility.
- 10. The products are not designed to be radiation-proof. The necessary radiation measures should be taken in the product design by the customer depending on the intended use.
- 11. The products do not affect human health under normal use. However, they contain chemical substances and heavy metals and should therefore not be put in the mouth. The fracture surfaces of wafers and chips may be sharp. Be careful when handling these with the bare hands to prevent injuries, etc.
- 12. When disposing of the products, comply with the laws and ordinances of the country or region where they are used.
- 13. The information described herein contains copyright information and know-how of ABLIC Inc. The information described herein does not convey any license under any intellectual property rights or any other rights belonging to ABLIC Inc. or a third party. Reproduction or copying of the information from this document or any part of this document described herein for the purpose of disclosing it to a third-party is strictly prohibited without the express permission of ABLIC Inc.
- 14. For more details on the information described herein or any other questions, please contact ABLIC Inc.'s sales representative.
- 15. This Disclaimers have been delivered in a text using the Japanese language, which text, despite any translations into the English language and the Chinese language, shall be controlling.



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Battery Management category:

Click to view products by Ablic manufacturer:

Other Similar products are found below:

MP26121DQ-LF-P NCP1855FCCT1G FAN54063UCX LC05132C01NMTTTG SN2040DSQR ME4075AM5G AP5054HTCER TC2120-NB XPD977B XPD977B18 4056H DW01 DW06 CM1002-UD CM1002-W CM1002-X CM1002-Y CM1006-B CM1006-Q CM1006-WB CM1006-LCD CM1006-LBD CM1006-WF CM1006-LF CM1006-WG CM1006-WH CM1006-LG CM1003-S02BD CM1003-S09EA CM1003-S10ED CM1003-S11ED CM1003-S12BC CM1003-S13CC CM1003-S24BC CM1003-S26BC CM1003-WAD CM1003-BBD CM1003-BFD CM1003-BND CM1003-BLD CM1003-DAD CM1003-BMD CM1003-BPD CM1003-BKD CM1003-BAE CM1003-BHE CM1102B-FF CM1102B-FD CM1102B-GD CM1112-DAE